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Features

FAIRCHILD

- Shielded Gate MOSFET Technology
- Max r_{DS(on)} = 22.5 mΩ at V_{GS} = 10 V, I_D = 8 A
- Max $r_{DS(on)}$ = 31 m Ω at V_{GS} = 4.5 V, I_D = 7 A
- HBM ESD protection level > 6 kV typical (Note 4)
- Very low Qg and Qgd compared to competing trench technologies
- Fast switching speed
- 100% UIL tested
- RoHS Compliant



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General Description

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench $^{\textcircled{M}}$ process that incorporates Shielded Gate technology. This process has been optimized for the on-state resistance and switching loss. G-S zener has been added to enhance ESD voltage level.

Applications

- DC DC Conversion
- Inverter
- Synchronous Rectifier

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MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted

D-PAK (TO-252)

Symbol	Parameter			Ratings	Units	
V _{DS}	Drain to Source Voltage			100	V	
V _{GS}	Gate to Source Voltage			±20	V	
	Drain Current -Continuous	T _C = 25 °C		35		
I _D	-Continuous	T _A = 25 °C	(Note 1a)	8	Α	
	-Pulsed			40		
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	84	mJ	
P _D	Power Dissipation	T _C = 25 °C		54		
	Power Dissipation	T _A = 25 °C	(Note 1a)	3.1		
T _J , T _{STG}	Operating and Storage Junction Temperature Range			-55 to +150	°C	

Thermal Characteristics

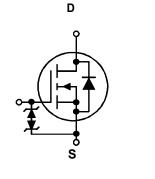
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.3	°C/W	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient (Note 1a)	40	C/VV	

Package Marking and Ordering Information

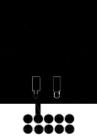
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDD86102LZ	FDD86102LZ	D-PAK(TO-252)	13 "	16 mm	2500 units



FDD86102LZ N-Channel Shielded Gate PowerTrench[®] MOSFET

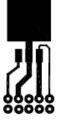


Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
ΔBV_{DSS} ΔT_J	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		69		mV/°C
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±10	μA
On Chara	cteristics (Note 2)					
V _{GS(th)}	Gate to Source Threshold Voltage	V _{GS} = V _{DS} , I _D = 250 μA	1.0	1.5	3.0	V
$\Delta V_{GS(th)}$ $\Delta T_{.1}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$, referenced to 25 °C		-6		mV/°C
r _{DS(on)}	•	V _{GS} = 10 V, I _D = 8 A		17.8	22.5	
	Static Drain to Source On Resistance	V _{GS} = 4.5 V, I _D = 7 A		23.2	31	mΩ
		V _{GS} = 10 V, I _D = 8 A, T _J = 125 °C		31.1	40	1
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 8 A		31		S
-	Characteristics			1157	1540	~ [
C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V,		1157 181	1540 245	pF pF
C _{oss}	Output Capacitance	f = 1 MHz		7.7	245 15	
C _{rss} R _g	Reverse Transfer Capacitance Gate Resistance			0.6	15	pF Ω
				0.0		32
	g Characteristics			0.0	44	
t _{d(on)}	Turn-On Delay Time			6.6	14	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 8 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		2.3	10	ns
t _{d(off)}	Turn-Off Delay Time	V _{GS} = 10 V, K _{GEN} = 0.52		20	32	ns
t _f	Fall Time			2.3	10	ns
Q _g	Total Gate Charge Total Gate Charge	$V_{GS} = 0 \text{ V to } 10 \text{ V}$ $V_{GS} = 0 \text{ V to } 4.5 \text{ V}$ $V_{DD} = 50 \text{ V},$		18 8.7	26 13	nC nC
Q _g	Gate to Source Gate Charge	$V_{GS} = 0 V 10 4.3 V V_{DD} = 50 V,$ $I_D = 8 A$		2.7	15	nC
Q _{gs} Q _{gd}	Gate to Drain "Miller" Charge			2.4		nC
•				2.4		110
Jrain-Sol	in-Source Diode Characteristics			0.00	1.0	1
V _{SD}	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 8 A$ (Note 2)		0.82	1.3	V
		$V_{GS} = 0 V, I_S = 2.6 A$ (Note 2)		0.75	1.2	20
	Reverse Recovery Time Reverse Recovery Charge	— I _F = 8 A, di/dt = 100 A/μs		43 43	70	ns nC
Q _{rr} lotes:	Reverse Recovery Charge			40	70	IIC



a. 40 °C/W when mounted on a 1 in² pad of 2 oz copper.

4. The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



b. 96 °C/W when mounted on a minimum pad of 2 oz copper.

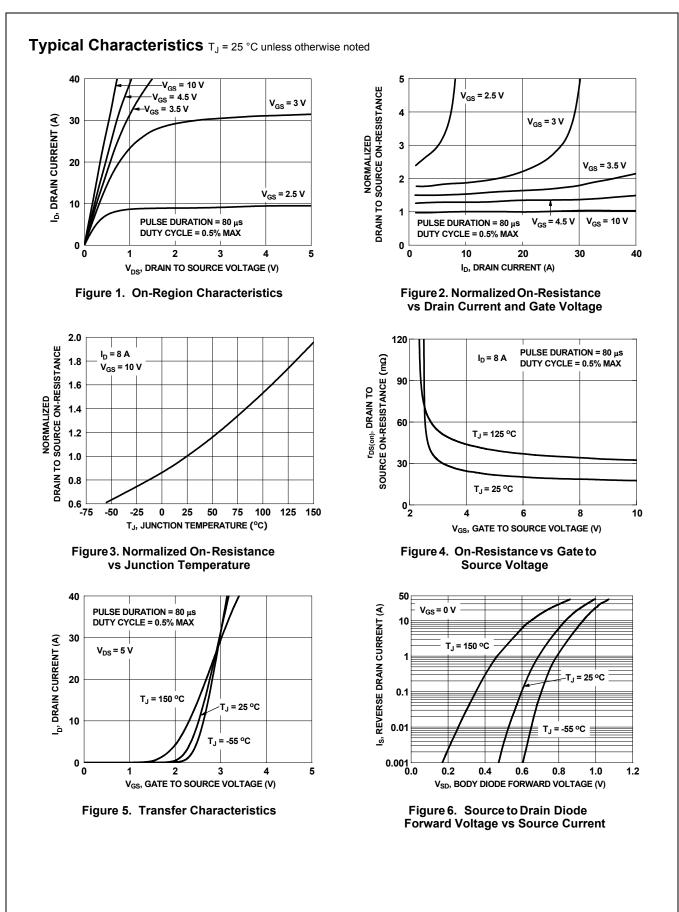
FDD86102LZ N-Channel Shielded Gate PowerTrench[®] MOSFET

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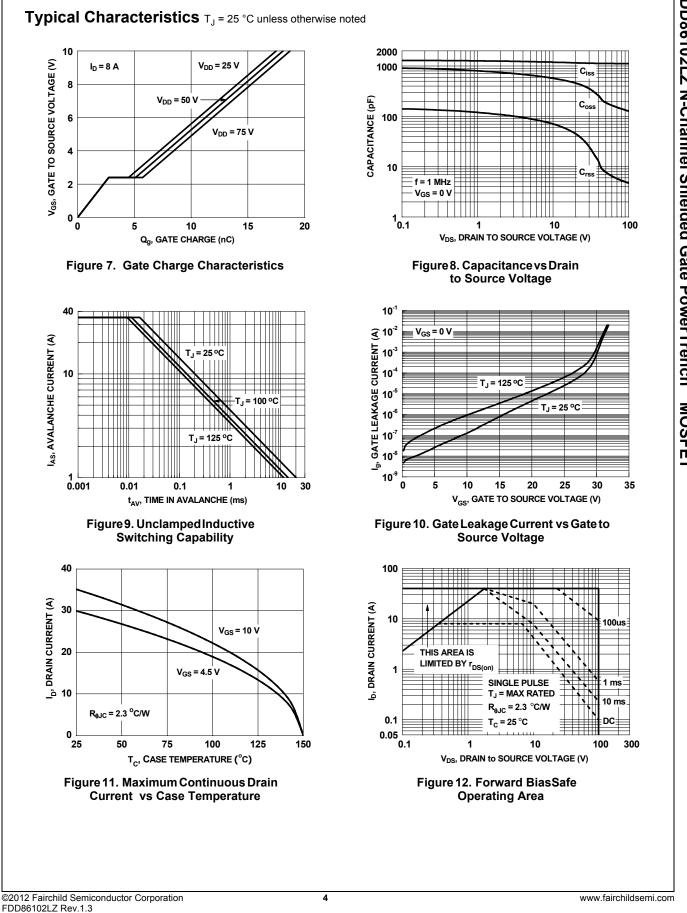
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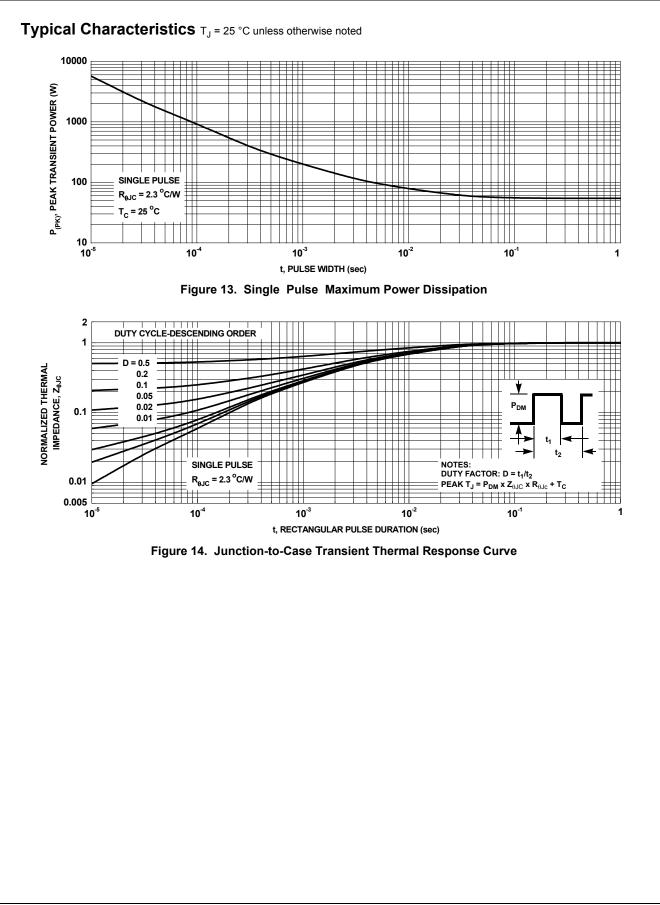
2. Pulse Test: Pulse Width < 300 $\mu s,$ Duty cycle < 2.0%.

3. Starting T_J = 25°C, L = 1 mH, I_{AS} = 13 A, V_{DD} = 90 V, V_{GS} = 10 V.

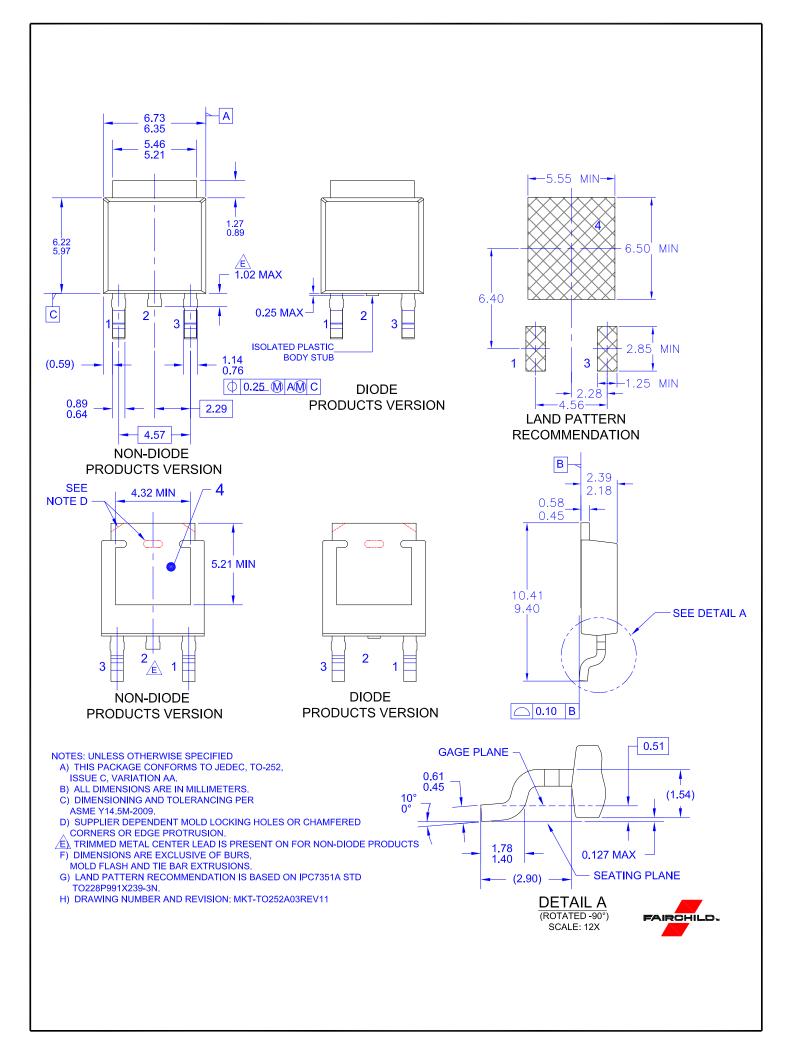


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FDD86102LZ N-Channel Shielded Gate PowerTrench[®] MOSFET



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